Ref	Hits	Search Query	DBs	Default	Plurals	Time Sta
#	піс	Search Query	DBS	Operator	Plurais	Time Stamp
S1	3	(Takanori Kurokawa.in.) and (Kazuo Fukaya.in.) and (Takahiro Ichikawa. in.) and (takashige Nagoya.in.) and (Taketoshi Minami.in.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 15:27
S2	115	(204/157.74).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:28
S3	468	(72/350).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:28
S4	910	(72/347).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:28
S5	479	(72/351).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:28
S6	425	(72/462).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:28
S7	3035	(428/403).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:28
S19	18	(204/157.74.ccls.) and (press mold die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:51

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S20	485	(72/347.ccls.) and (press molding die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:51
S21	15	(204/157.74.ccls.) and (press molding die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:52
S22	9	(204/157.74.ccls.) and (press molding die) and (coating layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 15:53
S23	10	(204/157.74.ccls.) and (press molding die) and (coating layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 15:56
S24	81	(72/347.ccls.) and (press molding die) and (coating layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 15:59
S28	26	("4745792")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/29 09:54
S29	13	("0682866" "1970134" "2321075" "2354005" "2980046" "4745792" "5505071").PN. OR ("6354131").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/29 09:39
S30	25	("0682866" "3349153" "3420089" "3494169" "4090389").PN. OR ("4745792").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/29 09:40
S31	3	("2002068108")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/29 09:55

						
S32	8	("068108")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/29 09:58
S33	1	("2002-068108") ·	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/29 09:59
S35	2	("20020068108").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/29 10:14
S36	180335	(punch)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 16:00
S37	62911	(punch) and (press)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 16:00
S38	5711	(punch) and (press) and (workpiece)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 16:00
S39	205	(punch) and (press) and (workpiece) and (molding same die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 16:01
S40	3	(punch) and (press) and (workpiece) and (molding same die) and (micro same rough)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 16:03

S41	2	(punch) and (molding same die) and (pad) and (micro same rough same layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 16:04
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